

ICSEM 2021

Call for Paper

2021 6th International Conference on
Smart Engineering Materials (ICSEM 2021)

Nha Trang, Vietnam / January 8-10, 2021

Important Dates:

Submission Deadline: Aug. 20, 2020
Notification Deadline: Sept. 10, 2020
Registration Deadline: Sept. 30, 2020

Conference Topics:

Carbonaceous Materials
Metallurgical Science
Wide Band Gap Materials
Metallurgical Fundamentals and Techniques
Nanomaterials and their Arrangements

For more topics, please visit:

<http://www.icsem.org/cfp.html>

Submission Methods:

1. System submission:

<http://confsys.iconf.org/submission/icsem2021>

2. Email submission

icsem@cbees.net

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Organized by:



Publication:

The accepted papers with registration and presentation will be published in **Materials Science Forum**, (ISSN print 0255-5476 / ISSN web 1662-9752) which is indexed by **Ei Compindex**, **Scopus**.

Speakers:

1. Prof. Nguyen Quang Liem, from Vietnam Academy of Science and Technology, Hanoi, Vietnam
2. Prof. Frank Otremba, from Federal Institute for Material Research and Testing, Germany
3. Prof. Jae-Jin Shim, from Yeungnam University, South Korea
4. Prof. Takashige Omatsu (Fellow of JSAP, OSA, SPIE), from Chiba University, Japan
5. Prof. Anja Pfennig, from HTW-Berlin University of Applied Sciences, Germany
6. Prof. Dae-Eun Kim, from Yonsei University, Korea

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